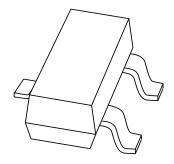
DISCRETE SEMICONDUCTORS

DATA SHEET



BBY40VHF variable capacitance diode

Product specification Supersedes data of November 1993 1996 May 03



NXP Semiconductors Product specification

VHF variable capacitance diode

BBY40

FEATURES

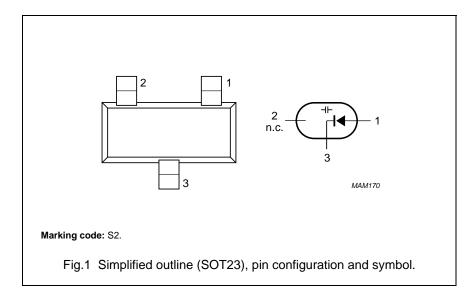
- · Excellent linearity
- Small plastic SMD package
- C25: 4.6 pF; ratio: 5.5.

APPLICATIONS

• Electronic tuning in VHF television tuners, band A up to 160 MHz.

DESCRIPTION

The BBY40 is a variable capacitance diode, fabricated in planar technology, and encapsulated in the SOT23 small plastic SMD package.



LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 134).

| SYMBOL | PARAMETER | MIN. | MAX. | UNIT |
|------------------|--------------------------------|------|------|------|
| V_R | continuous reverse voltage | | 30 | V |
| I _F | continuous forward current | | 20 | mA |
| T _{stg} | storage temperature | | +150 | °C |
| T _i | operating junction temperature | | +125 | °C |

ELECTRICAL CHARACTERISTICS

 $T_j = 25$ °C; unless otherwise specified.

| SYMBOL | PARAMETER | CONDITIONS | | TYP. | MAX. | UNIT |
|--------------------------------|-------------------------|--|-----|------|------|------|
| I _R | reverse current | V _R = 28 V; see Fig.3 | _ | _ | 10 | nA |
| | | $V_R = 28 \text{ V}; T_j = 85 \text{ °C}; \text{ see Fig.3}$ | _ | _ | 200 | nA |
| r _s | diode series resistance | f = 200 MHz; note 1 | _ | _ | 0.7 | Ω |
| C_d | diode capacitance | $V_R = 3 \text{ V}$; f = 1 MHz; see Figs 2 and 4 | 26 | _ | 32 | pF |
| | | $V_R = 25 \text{ V}$; f = 1 MHz; see Figs 2 and 4 | 4.3 | _ | 6 | pF |
| $\frac{C_{d(3V)}}{C_{d(25V)}}$ | capacitance ratio | f = 1 MHz | 5 | _ | 6.5 | |

Note

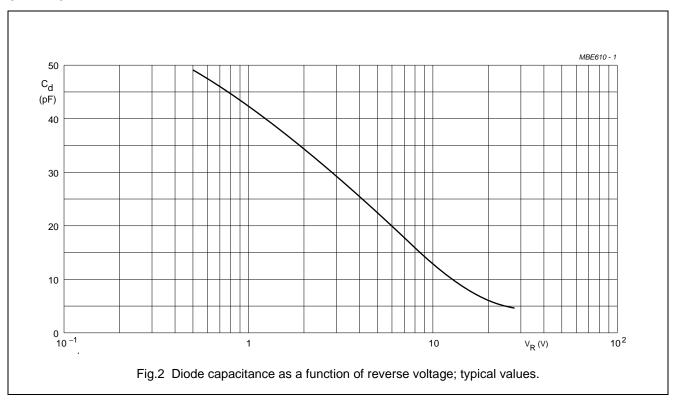
1. V_R is the value at which $C_d = 25 pF$.

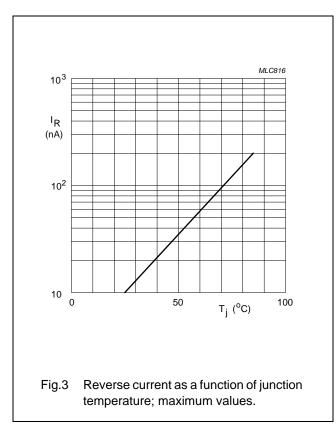
1996 May 03 2

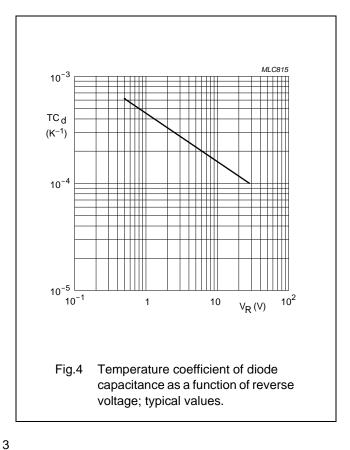
VHF variable capacitance diode

BBY40

GRAPHICAL DATA







1996 May 03

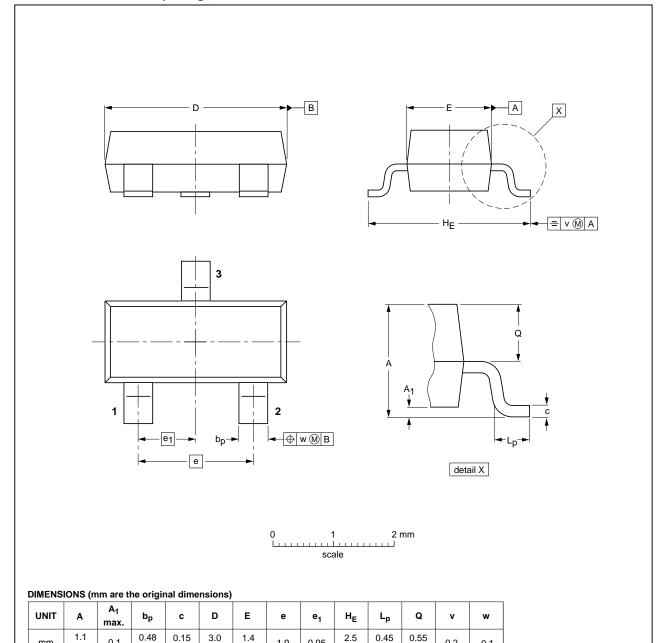
VHF variable capacitance diode

BBY40

PACKAGE OUTLINE

Plastic surface-mounted package; 3 leads

SOT23



| OUTLINE | REFERENCES | | | EUROPEAN | ISSUE DATE | | |
|---------|------------|----------|-------|----------|------------|----------------------------------|--|
| VERSION | IEC | JEDEC | JEITA | | PROJECTION | 1330E DATE | |
| SOT23 | | TO-236AB | | | | -04-11-04 06-03-16 | |

0.2

0.1

0.95

1.9

1996 May 03 4

0.1

0.9

NXP Semiconductors Product specification

VHF variable capacitance diode

BBY40

DATA SHEET STATUS

| DOCUMENT STATUS ⁽¹⁾ | PRODUCT STATUS ⁽²⁾ | DEFINITION |
|-----------------------------------|----------------------------------|---|
| Objective data sheet | Development | This document contains data from the objective specification for product development. |
| Preliminary data sheet | Qualification | This document contains data from the preliminary specification. |
| Product data sheet Production | | This document contains the product specification. |

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1996 May 03 5

NXP Semiconductors Product specification

VHF variable capacitance diode

BBY40

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1996 May 03 6

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Customer notification

This data sheet was changed to reflect the new company name NXP Semiconductors, including new legal definitions and disclaimers. No changes were made to the technical content, except for package outline drawings which were updated to the latest version.

Contact information

For additional information please visit: http://www.nxp.com
For sales offices addresses send e-mail to: salesaddresses@nxp.com

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